SDLS147 - SEPTEMBER 1972 - REVISED MARCH 1988

- Three-State Version of SN54/74LS153, SN54/74S153
- Schottky-Diode-Clamped Transistors
- Permits Multiplexing from N Lines to 1 Line
- Performs Parallel-to Serial Conversion
- Fully Compatible with Most TTL Circuits
- Low Power Dissipation

'LS253 . . . 35 mW Typical 'S253 . . . 225 mW Typical

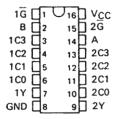
description

Each of these Schottky-clamped data selectors/multiplexers contains inverters and drivers to supply fully complementary, on-chip, binary decoding data selection to the AND-OR gates. Separate output control inputs are provided for each of the two four-line sections.

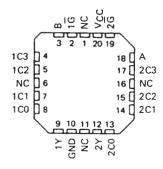
The three-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (at a high-impedance state) the low-impedance of the single enabled output will drive the bus line to a high or low logic level.

SN54LS253, SN54S253 . . . J OR W PACKAGE SN74LS253, SN74S253 . . . D OR N PACKAGE

(TOP VIEW)



SN54LS253, SN54S253 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

FUNCTION TABLE

1	ECT UTS		DATA	INPUTS		OUTPUT CONTROL	ОUТРUТ
В	Α	CO	C1	C2	C3	Ğ	Υ
X	X	X	X	X	X	Н	Z
Ł	L	L	X	X	X	L	L
L	L	Н	X	X	X	L	н
L	Н	×	L	X	Х	L	L
L	Н	×	Н	X	X	L	н
Н	L	×	×	L	×	L	L
н	L	×	X	Н	X	L	Н
H	Н	×	X	X	L	L	L
Н	H	X	X	X	Н	L	Н

Address inputs A and B are common to both sections.

H = high fevel, L = low level, X = irrelevant, Z = high impedance (off)

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

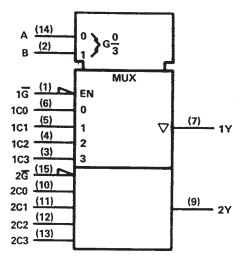
Supply voltage, VCC (see Note 1)			<i>.</i>	7 V
Input voltage: 'LS253				7 V
′S253				5.5 V
Off-state output voltage				
Operating free-air temperature range	: SN54LS253, SN54S253	;		- 55°C to 125°C
	SN74LS253, SN74S253			
Storage temperature range				-65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

TEXAS INSTRUMENTS

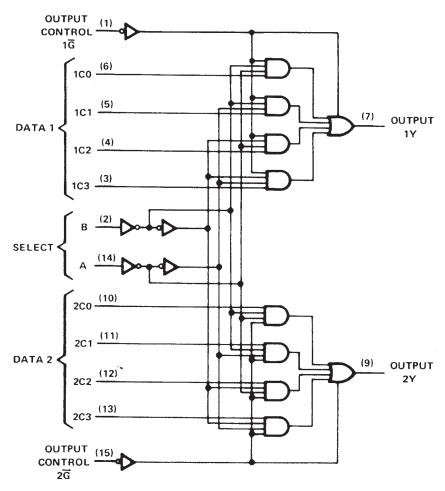
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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

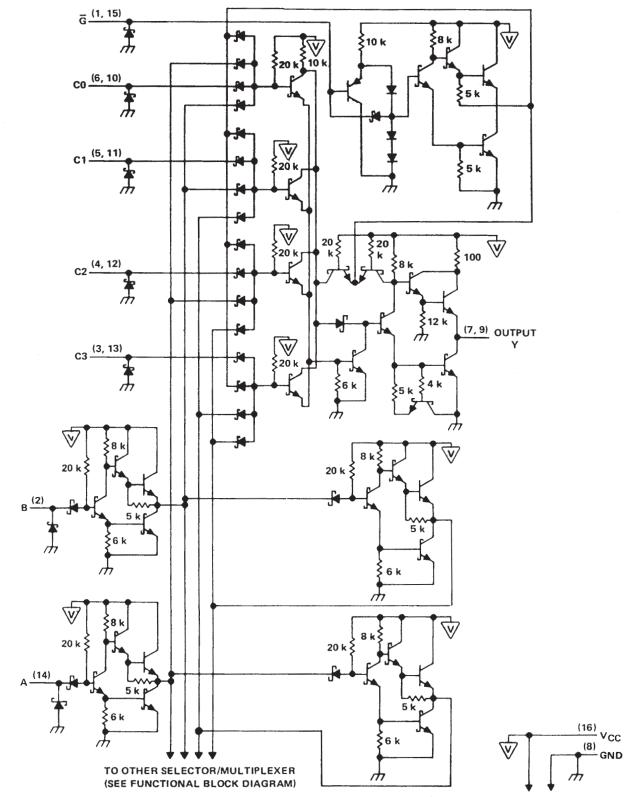
logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



schematic (each selector/multiplexer, and the common select section)



Pin numbers shown are for D, J, N, and W packages.



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recommended operating conditions

***************************************		S	N54LS2	53	S	N74LS2	53	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
Іон	High-level output current			- 1			- 2.6	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITI	ONCT		S	N54LS2	53	S	N74LS2	53	UNIT
FANAMETEN		1521 CONDITI	ONS		MIN	TYP \$	MAX	MIN	TYP‡	MAX	
VIK	V _{CC} = MIN,	$I_1 = -18 \text{ mA}$					- 1.5			- 1.5	V
VOH	V _{CC} = MIN,	V _{IH} = 2 V,	VIL = MAX,	1 _{OH} = MAX	2.4	3.4		2.4	3.1		V
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	1/ - 14AV	IOL = 4 mA		0.25	0.4		0.25	0.4	V
VOL	ACC - MIIA	VIH - 2 V,	V, VIL = MAX	IOL = 8 mA		****			0.25	0.5	
loz	VCC = MAX,	V _{IH} = 2 V		V _O = 2.7 V			20			20	
102	VCC - WAX,	VIH - Z V		V _O = 0.4 V			- 20			20	μΑ
11	V _{CC} = MAX,	V ₁ = 7 V					0.1			0.1	mΑ
liH.	V _{CC} = MAX,	V _I = 2.7 V					20			20	μΑ
1	V _{CC} = MAX,	V ₁ = 0.4 V		Ğ			- 0.2			- 0.2	
115	VCC - MIAA,	V - 0.4 V		All other			- 0.4			- 0.4	, mA
Ios§	V _{CC} = MAX				- 30		- 130	- 30		- 130	mA
loo	Vac = MAY	San Note 2		Condition A		7	12		7	12	
¹cc	V _{CC} = MAX, See Note 2			Condition B		8.5	14		8.5	14	mA

[†] For conditions shown as MIN or MAX, use the appropriate value spcified under recommended operating conditions.

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH .	Data	Y			17	25	
tPHL.	Data	'			13	20	ns
^t PLH	Select		$C_L = 15 pF$, $R_L = 2 k\Omega$,		30	45	
tPHL.	Select	'	See Note 3	See Note 3	21	32	ns
^t PZH	Output	_			15	28	
^t PZL	Control	'			15	23	ns
^t PHZ	Output		$C_L = 5 pF$, $R_L = 2 k\Omega$,		27	41	
^t PLZ	Control	'	See Note 3		18	27	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time, and duration for the short-circuit should exceed one second.

A. All inputs grounded.

B. Output control at 4.5 V, all inputs grounded.

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recommended operating conditions

			N54S2	53	SN74S253			LINIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			- 6.5	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDIT	rions†		MIN	түр‡	MAX	UNIT
VIK	VCC = MIN,	I ₁ = - 18 mA						- 1.2	V
Vон	VCC = MIN,	V _{1H} = 2 V,	V _{1L} = 0.8 V,	IOH = MAX	Series 54S	2,5	3.4		V
* OH	VCC - WITH,	VIH - 2 V,	VIL - 0.8 V,	IOH = MAX	Series 74S	2.7	3.4		1 V
VOL	VCC = MIN,	VIH = 2 V,	VIL = 0.8 V,	IOL = 20 mA				0.5	V
loz	Vcc = MAX,	VIH = 2 V			V _O = 2.4 V			50	
	VCC - WAX,	VIH - Z V			V _O = 0.5 V			- 50	μА
1 ₁	V _{CC} = MAX,	V1 = 5.5 V						1	mA
IН	V _{CC} = MAX,	V _I = 2.7 V						50	μΑ
111	V00 - 110 V	V: - 0.5 V			G = 0.8 V			- 2	
•11.	VCC = MAX,	$V_1 = 0.5 V$			G = 2 V			- 0.25	mA
los§	V _{CC} = MAX				1	- 40		- 100	mA
Icc	CC V _{CC} = MAX, See Note 2		Voc = MAX See Note 2		Condition A		45	70	
	TOG = WAX,	See Note 2			Condition B		65	85	mA mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second.

NOTE 2: ICC is measured with the outputs open under the following conditions:

- A. All inputs grounded.
- B. Output control at 4.5 V, all inputs grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	TEST CONDITIONS			
^t PLH	Data	~			6	9	
^t PHL	Data	1			6	9	ns
^t PLH	Select	· ·	R _L = 280 Ω,	C _L = 15 pF	11.5	18	
^t PHL] 00.001	'	See Note 3	o_ ,o p.	12	18	ns
^t PZH	Output	· ·	***************************************		11	16.5	
^t PZL	Control				12	18	ns
^t PHZ	Output	V	R _L = 280 Ω,	C _L = 5 pF	6.5	9.5	
^t PLZ	Control	1	See Note 3		10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
76017012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76017012A SNJ54LS 253FK
7601701EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J
7601701EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J
JM38510/30908BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
JM38510/30908BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
JM38510/30908BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
JM38510/30908BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
JM38510/30908BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
JM38510/30908BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
JM38510/30908BFA.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
JM38510/30908BFA.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
M38510/30908BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
M38510/30908BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BEA
M38510/30908BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
M38510/30908BFA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 30908BFA
SN54LS253J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS253J
SN54LS253J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS253J





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Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN54LS253J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS253J
SN54LS253J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54LS253J
SN74LS253DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS253
SN74LS253DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS253
SN74LS253DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS253
SN74LS253DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS253
SN74LS253N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS253N
SN74LS253N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS253N
SN74LS253N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS253N
SN74LS253N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS253N
SNJ54LS253FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76017012A SNJ54LS 253FK
SNJ54LS253FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76017012A SNJ54LS 253FK
SNJ54LS253FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76017012A SNJ54LS 253FK
SNJ54LS253FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	76017012A SNJ54LS 253FK
SNJ54LS253J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J
SNJ54LS253J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J
SNJ54LS253J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J
SNJ54LS253J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	7601701EA SNJ54LS253J

⁽¹⁾ Status: For more details on status, see our product life cycle.

PACKAGE OPTION ADDENDUM

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(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54LS253, SN74LS253:

Catalog: SN74LS253

Military: SN54LS253

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS253DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	SN74LS253DR	SOIC	D	16	2500	340.5	336.1	32.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
76017012A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30908BFA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/30908BFA.A	W	CFP	16	25	506.98	26.16	6220	NA
M38510/30908BFA	W	CFP	16	25	506.98	26.16	6220	NA
SN74LS253N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS253N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS253N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS253N.A	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54LS253FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS253FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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